Docket No.: 55166US006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Tatsunori Koyanagi

Serial No.: Not Yet Known

Filed: March 26, 2002

For: MULTI-LAYER DOUBLE-SIDED

WIRING BOARD AND METHOD OF

FABRICATING THE SAME

O Group Art Unit: Not Yet Known

Examiner: Not Yet Known

D Examiner: Not Yet Known

D Examiner: Not Yet Known

PRELIMINARY AMENDMENT

Commissioner for Patents Washington, DC 20231

Dear Sir:

Please enter the following preliminary amendment in the above-referenced application.

In the Claims:

Please amend claim 3 as follows:

Claim 3 (Amended). A multi-layer double-sided wiring board according to claim 1, wherein the interface layer contains at least one metallic element selected from the group consisting of nickel, cobalt, zinc, and chromium.

A version marked up to show changes made to the claim(s) relative to the previous version of the claim(s) is attached.

Examination and consideration of the application as amended is requested.

Registration Number 31,783 Telephone Number 512-984-3578
Date

Office of Intellectual Property Counsel
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St. Paul, Minnesota 55133-3427 Facsimile: (651) 736-3833 Respectfully submitted,

Bv

Darla P. Fonseca